



# Product Change Notification

**Change Notification #:** 116292 - 00  
**Change Title:** Intel® RAID Controller RMS3HC080,  
PCN 116292-00, Product Design,  
Firmware and standoffs upgrade  
**Date of Publication:** June 04, 2018

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	June 19, 2018
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® RAID Module RMS3HC080:

1. Upgrade the controller's firmware package version 24.15.0-0034 (MR 6.11p2)
2. Upgrade the stand-offs to include a pull tab to make removal easier

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes. Customers may need to validate the function and feature change once the post-change system is available.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
RMS3HC080	932469	H17951-004	H24093-203	H17951-005	H24093-204

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
June 4, 2018	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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